

### Vishay High Power Products

# HEXFRED® Ultrafast Soft Recovery Diode, 6 A



Anode

100 A/µs

4.4 A

PRODUCT SUMMARY						
$V_{R}$	1200 V					
V <sub>F</sub> at 6 A at 25 °C	3.0 V					
I <sub>F(AV)</sub>	6 A					
t <sub>rr</sub> (typical)	26 ns					
T <sub>J</sub> (maximum)	150 °C					
Q <sub>rr</sub> (typical)	116 nC					

dI<sub>(rec)M</sub>/dt (typical) at 125 °C

I<sub>RRM</sub> (typical)

#### **FEATURES**

- Ultrafast recovery
- Ultrasoft recovery
- Very low I<sub>RRM</sub>
- Very low Q<sub>rr</sub>
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

#### **BENEFITS**

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- · Reduced snubbing
- · Reduced parts count

#### **DESCRIPTION**

VS-HFA06TB120S is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 6 A continuous current, the VS-HFA06TB120S is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I<sub>RRM</sub>) and does not exhibit any tendency to "snap-off" during the t<sub>h</sub> portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA06TB120S is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Cathode to anode voltage	$V_{R}$		1200	V		
Maximum continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 100 °C	6			
Single pulse forward current	I <sub>FSM</sub>		80	Α		
Maximum repetitive forward current	I <sub>FRM</sub>		24			
Maximum naviar discination	Б	T <sub>C</sub> = 25 °C	62.5	W		
Maximum power dissipation	$P_{D}$	T <sub>C</sub> = 100 °C	25	VV		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to + 150	°C		







## VS-HFA06TB120SPbF

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<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Cathode to anode breakdown voltage	V <sub>BR</sub>	V <sub>BR</sub> I <sub>R</sub> = 100 μA		-	-		
		I <sub>F</sub> = 6.0 A	-	2.7	3.0	V	
Maximum forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 12 A	-	3.5	3.9		
		I <sub>F</sub> = 6.0 A, T <sub>J</sub> = 125 °C	-	2.4	2.8	í	
Maximum reverse I <sub>RM</sub>		$V_R = V_R$ rated	-	0.26	5.0		
		$T_J = 125$ °C, $V_R = 0.8 \times V_R$ rated	-	110	500	μΑ	
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 200 V - 9.0		14	pF		
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body - 8.0 -		nH			

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		-	26	-	
Reverse recovery time	t <sub>rr1</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 6.0 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	53	80	ns A
	t <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	87	130	
Peak recovery current	I <sub>RRM1</sub>	T <sub>J</sub> = 25 °C		-	4.4	8.0	
	I <sub>RRM2</sub>	T <sub>J</sub> = 125 °C		-	5.0	9.0	
Reverse recovery charge	Q <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	116	320	
	Q <sub>rr2</sub>	T <sub>J</sub> = 125 °C		-	233	585	110
Peak rate of recovery current during $t_{\mbox{\scriptsize b}}$	dI <sub>(rec)M</sub> /dt1	T <sub>J</sub> = 25 °C		-	180	-	Λ /
	dI <sub>(rec)M</sub> /dt2	T <sub>J</sub> = 125 °C		-	100	-	A/μs

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Lead temperature	T <sub>lead</sub>	0.063" from case (1.6 mm) for 10 s	-	-	300	°C	
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	2.0		
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	80	K/W	
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.5	-		
Weight			-	2.0	-	g	
vveignt			-	0.07	-	oz.	





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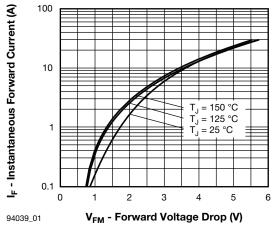


Fig. 1 - Typical Forward Voltage Drop Characteristics

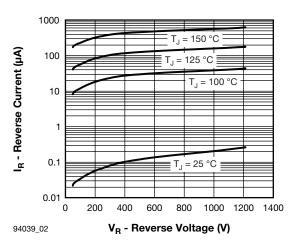


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

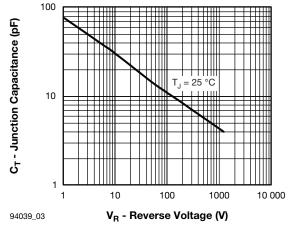


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

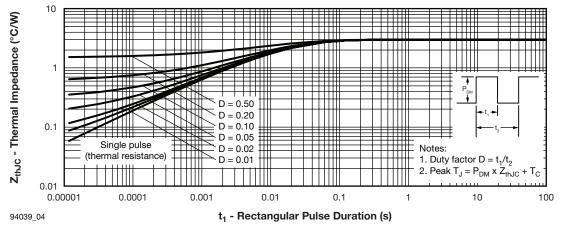


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

### VS-HFA06TB120SPbF

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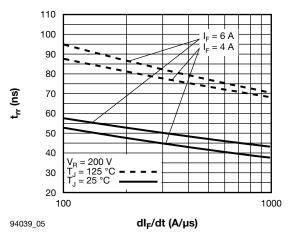


Fig. 5 - Typical Reverse Recovery Time vs. dI<sub>F</sub>/dt

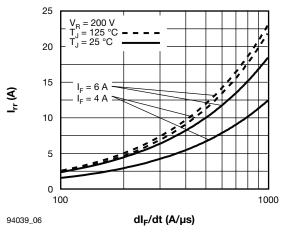


Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt

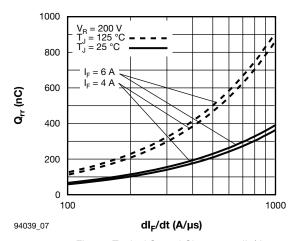


Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$ 

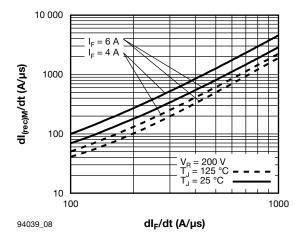


Fig. 8 - Typical  $dI_{(rec)M}/dt$  vs.  $dI_F/dt$ 



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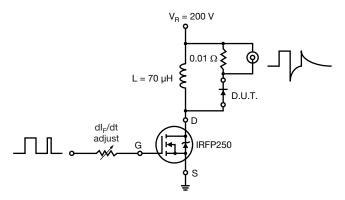
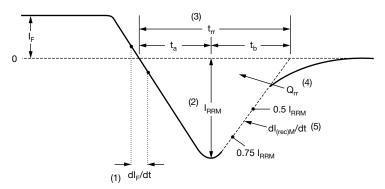


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl<sub>F</sub>/dt rate of change of current through zero crossing
- (2)  $I_{RRM}$  peak reverse recovery current
- (3)  $t_{\rm rr}$  reverse recovery time measured from zero crossing point of negative going  $I_{\rm F}$  to point where a line passing through 0.75  $I_{\rm RRM}$  and 0.50  $I_{\rm RRM}$  extrapolated to zero current.
- (4)  $\mathbf{Q}_{\rm rr}$  area under curve defined by  $\mathbf{t}_{\rm rr}$  and  $\mathbf{I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) dl<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 10 - Reverse Recovery Waveform and Definitions

### VS-HFA06TB120SPbF

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#### **ORDERING INFORMATION TABLE**

Device code

VS-	HF	A	06	ТВ	120	S	TRL	PbF
1	2	3	4	5	6	7	8	9

- 1 HPP product suffix
- 2 HEXFRED® family
- 3 Process designator: A = Electron irradiated
- 4 Current rating (06 = 6 A)
- Package outline (TB = TO-220, 2 leads)
- 6 Voltage rating (120 = 1200 V)
- $7 S = D^2PAK$
- None = Tube (50 pieces)
  - TRL = Tape and reel (left oriented)
  - TRR = Tape and reel (right oriented)
- 9 PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95046</u>					
Part marking information	www.vishay.com/doc?95054				
Packaging information	www.vishay.com/doc?95032				



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